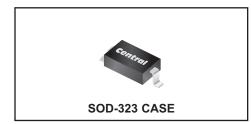


## SURFACE MOUNT SILICON HIGH CURRENT SCHOTTKY DIODE





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# DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMDSH2-3 is a silicon Schottky diode, manufactured in a SOD-323 surface mount package, designed for applications requiring a low forward voltage drop.

## MARKING CODE: S2

<b>MAXIMUM RATINGS:</b> (T <sub>A</sub> =25°C) Peak Repetitive Reverse Voltage		SYMBOL V <sub>RRM</sub>	30		UNITS V
Continuous Forward Current		I <sub>F</sub>	200		mA
Peak Forward	d Surge Current, tp=10ms	IFSM	1.0		А
Power Dissip	Power Dissipation		250		mW
Operating an	d Storage Junction Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150		°C
Thermal Res	istance	$\Theta_{JA}$	500		°C/W
ELECTRICA SYMBOL <sup>I</sup> R	L CHARACTERISTICS: $(T_A=25^{\circ}C)$ TEST CONDITIONS $V_R=30V$	MIN	<b>TYP</b> 19	<b>MAX</b> 50	UNITS μA
BVR	I <sub>R</sub> =100μΑ	30			V
V <sub>F</sub>	I <sub>F</sub> =2.0mA		0.186		V
V <sub>F</sub>	I <sub>F</sub> =15mA		0.245		V
VF	I <sub>F</sub> =100mA		0.35		V
V <sub>F</sub>	I <sub>F</sub> =200mA		0.42	0.55	V
СЈ	V <sub>R</sub> =10V, f=1.0MHz		6.0		pF

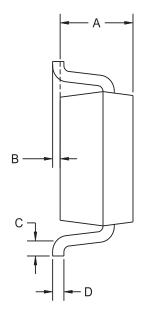
R4 (13-November 2015)

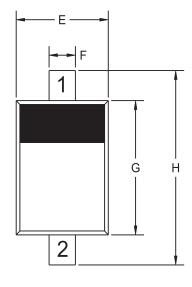


CMDSH2-3

SURFACE MOUNT SILICON HIGH CURRENT SCHOTTKY DIODE

## SOD-323 CASE - MECHANICAL OUTLINE





R4

LEAD CODE:1) Cathode2) Anode

MARKING CODE: S2

DIMENSIONS								
	INCHES		MILLIMETERS					
SYMBOL	MIN	MAX	MIN	MAX				
A	0.031	0.039	0.80	1.00				
В	0.000	0.004	0.00	0.10				
С	0.008	-	0.20	-				
D	0.004	0.007	0.11	0.19				
E	0.045	0.053	1.15	1.35				
F	-	0.014	-	0.35				
G	0.063	0.071	1.60	1.80				
Н	0.094	0.102	2.40	2.60				
SOD-323 (REV: R4)								

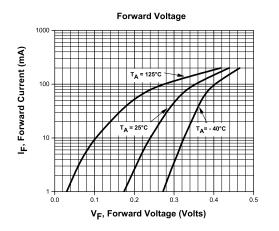
R4 (13-November 2015)

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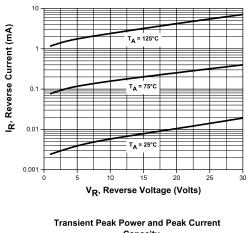


CMDSH2-3

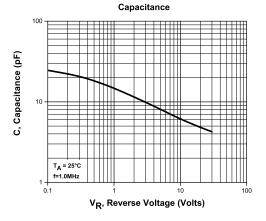
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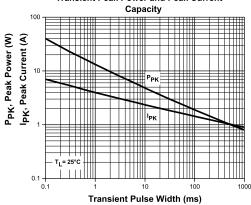


#### TYPICAL ELECTRICAL CHARACTERISTICS



Leakage Current





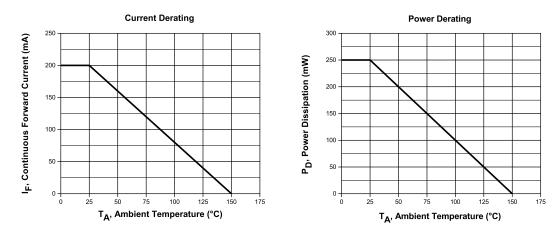
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## TYPICAL ELECTRICAL CHARACTERISTICS

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## **OUTSTANDING SUPPORT AND SUPERIOR SERVICES**

#### **PRODUCT SUPPORT**

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- · Consolidated shipping options

#### **DESIGNER SUPPORT/SERVICES**

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities

ss your design challenges.

· Custom product packing

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits

Custom bar coding for shipments

Custom product and package development

#### **REQUESTING PRODUCT PLATING**

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

## CONTACT US

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